

MOSFET

OptiMOS[™] 5 Power-Transistor, 100 V

Features

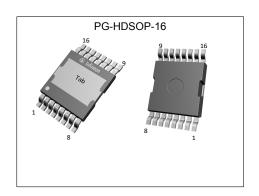
- N-channel
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

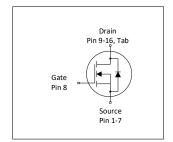
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	100	V
$R_{\mathrm{DS(on),max}}$	1.4	mΩ
I _D	365	A
Qoss	213	nC
Q _G	168	nC











Type / Ordering Code	Package	Marking	Related Links
IPTC014N10NM5	PG-HDSOP-16	14N10NM5	-

OptiMOSTM 5 Power-Transistor, 100 V IPTC014N10NM5



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Ob. a.l	Values			1114	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - - -	- - -	365 258 216 37	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =6 V, T_{C} =100 °C V_{GS} =10V, T_{A} =25°C, R_{thJA} =40°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1460	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	775	mJ	I_D =150 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	375 3.8	W	T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition	
Farameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	0.2	0.4	°C/W	-	
Thermal resistance, junction - ambient, 6 cm² cooling area²)		-	-	40	°C/W	-	
Thermal resistance, junction - ambient, minimal footprint	R _{thJA}	-	-	62	°C/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	100	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.2	3.0	3.8	V	V _{DS} =V _{GS} , I _D =280 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	5.0 100	μΑ	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	1.3 1.6	1.4 2.0	mΩ	V _{GS} =10 V, I _D =150 A V _{GS} =6 V, I _D =75 A
Gate resistance ¹⁾	R _G	-	1.4	2.1	Ω	-
Transconductance	g fs	140	280	-	S	<i>V</i> _{DS} ≥2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =100 A

Table 5 **Dynamic characteristics**

Danamatan	Ob. a.l		Values			N / / T / O III
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	12000	16000	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	1800	2300	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	80	140	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	36	_	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	30	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	85	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	30	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Cumbal	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	53	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	Q _{g(th)}	-	36	-	nC	V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	34	51	nC	V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V
Switching charge	Q _{sw}	-	51	-	nC	V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Q g	-	168	211	nC	V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.4	-	V	V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	213	285	nC	V _{DS} =50 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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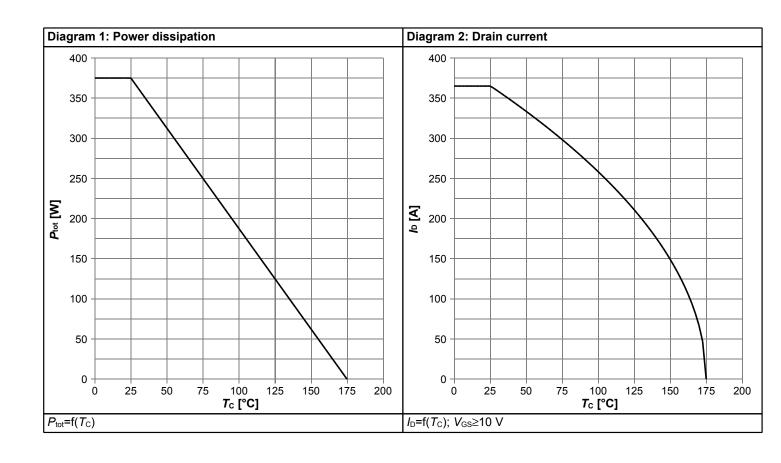


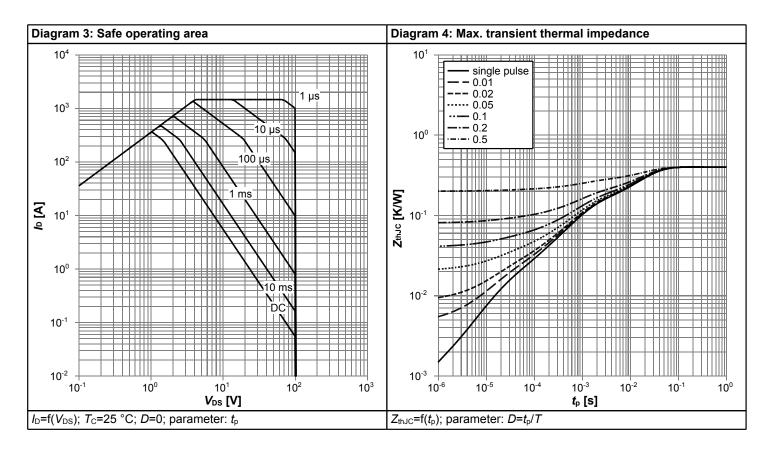
Table 7 Reverse diode

Danamatan	Symbol		Values			Nata / Tank Oam dition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	320	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1460	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.88	1.0	V	V _{GS} =0 V, I _F =150 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	103	206	ns	V _R =50 V, I _F =100 A, dI _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	316	632	nC	V_R =50 V, I_F =100 A, di_F/dt =100 A/ μ s

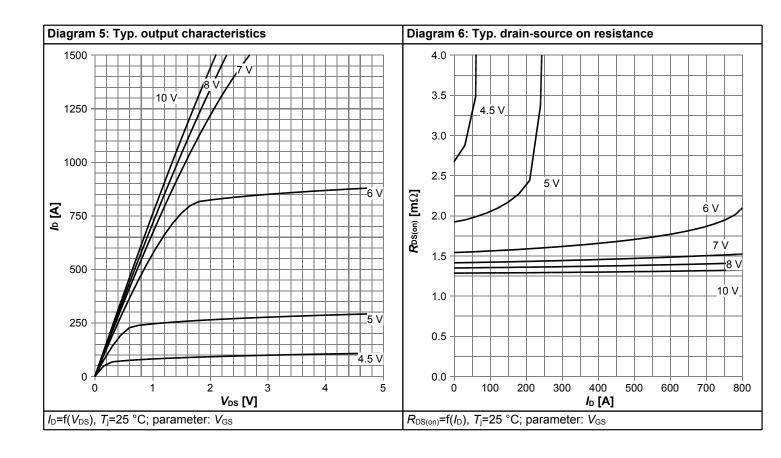


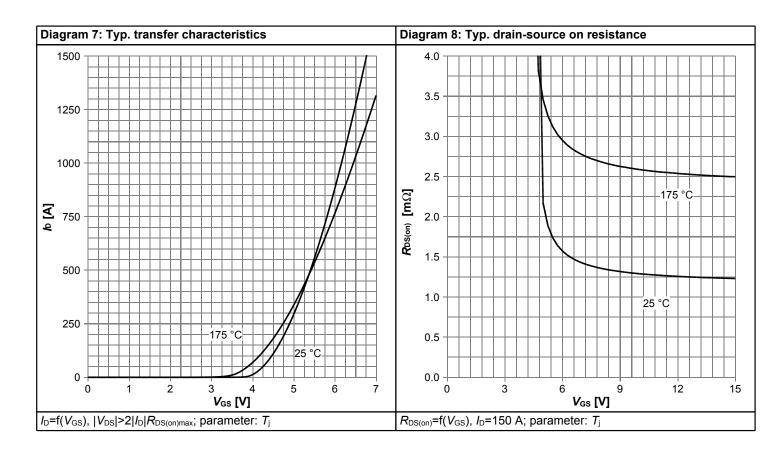
4 Electrical characteristics diagrams



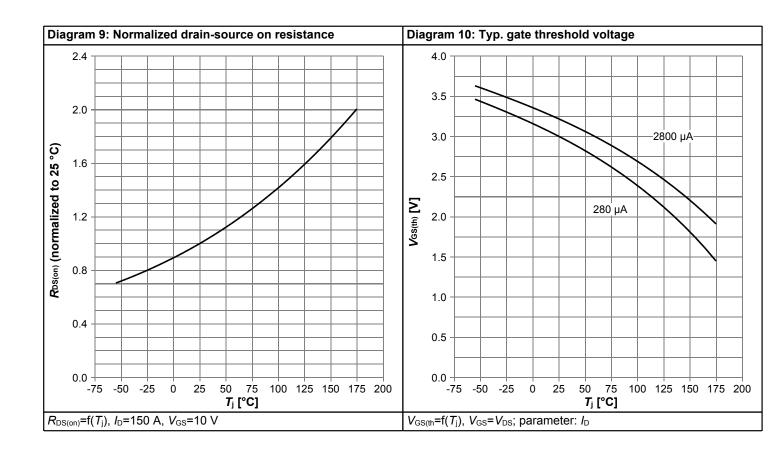


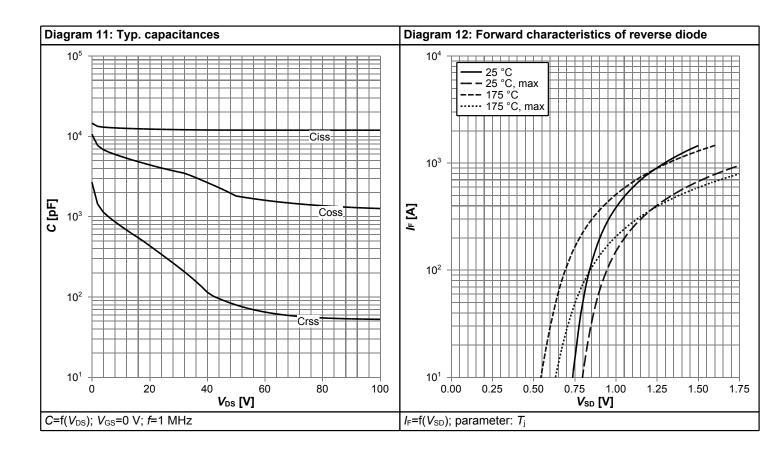




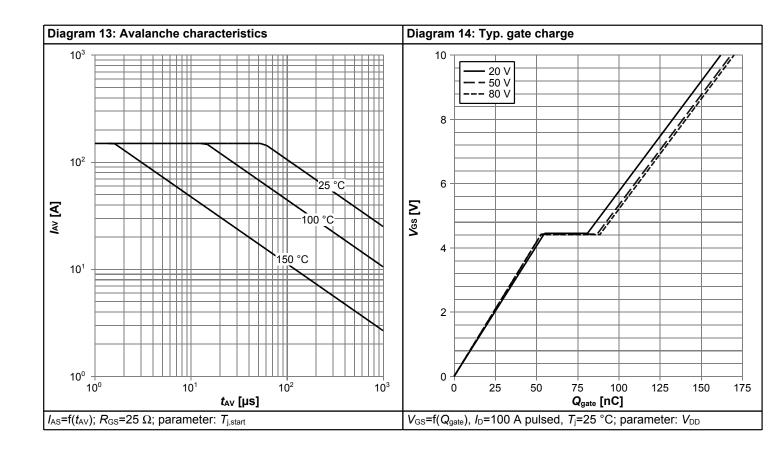


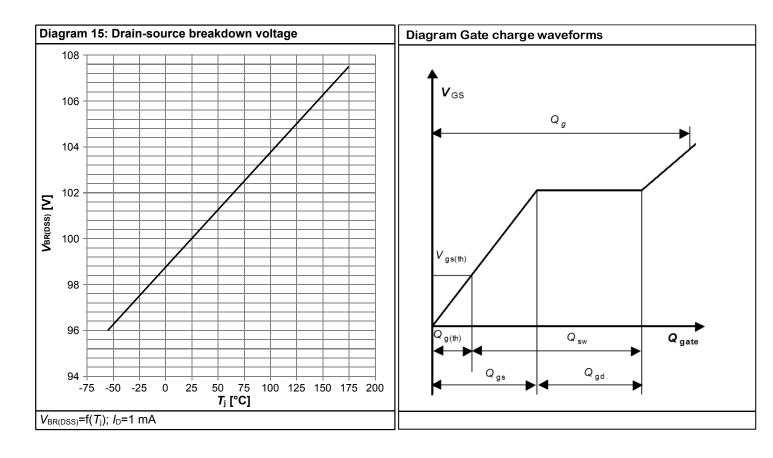






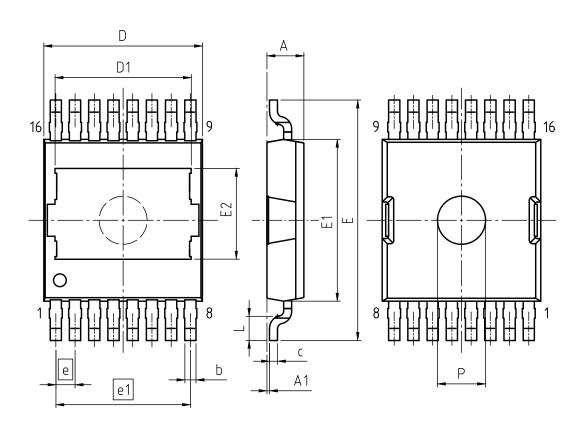








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-HDSC	P-16-U01
REVISION: 01	DATE:	18.12.2020
DIMENSIONS	MILLIM	ETERS
DIMENSIONS	MIN.	MAX.
Α	2.25	2.35
A1	0.01	0.16
b	0.60	0.80
С	0.40	0.60
D	9.70	10.10
D1	8.20	8.40
E	14.80	15.20
E1	10.00	10.30
E2	5.57	5.77
е	1.:	20
e1	8.	40
L	1.40	1.60
P	2.90	3.10

Figure 1 Outline PG-HDSOP-16, dimensions in mm



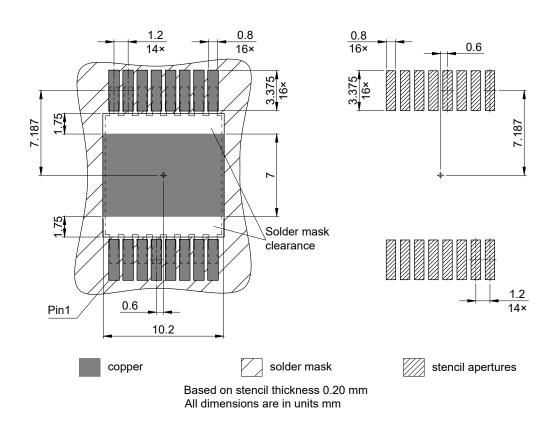
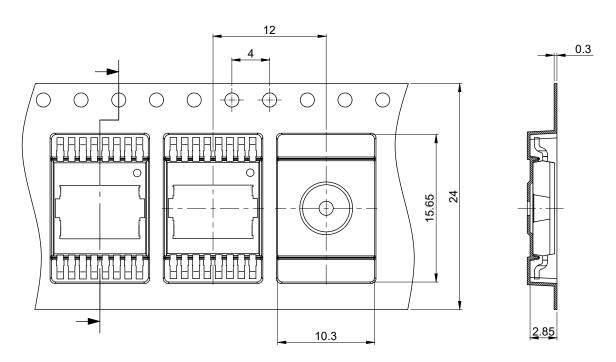


Figure 2 Outline Footprint (PG-HDSOP-16), dimensions in mm





All dimensions are in units mm

The drawing is in compliance with ISO 128-30, Projection Method 1 [

Figure 3 Outline Tape (PG-HDSOP-16), dimensions in mm

OptiMOSTM 5 Power-Transistor, 100 V



Revision History

IPTC014N10NM5

Revision: 2022-05-24, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2022-05-24	Release of final version			

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